



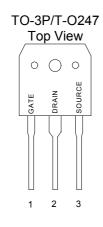
GENERAL DESCRIPTION

This high voltage MOSFET uses an advanced termination scheme to provide enhanced voltage-blocking capability without degrading performance over time. In addition, this advanced MOSFET is designed to withstand high energy in avalanche and commutation modes. The new energy efficient design also offers a drain-to-source diode with a fast recovery time. Designed for high voltage, high speed switching applications in power supplies, converters and PWM motor controls, these devices are particularly well suited for bridge circuits where diode speed and commutating safe operating areas are critical and offer additional and safety margin against unexpected voltage transients.

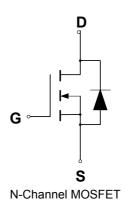
FEATURES

- ◆ Robust High Voltage Termination
- ◆ Avalanche Energy Specified
- Source-to-Drain Diode Recovery Time Comparable to a Discrete Fast Recovery Diode
- Diode is Characterized for Use in Bridge Circuits
- ◆ I_{DSS} and V_{DS}(on) Specified at Elevated Temperature
- ♦ Isolated Mounting Hole Reduces Mounting Hardware

PIN CONFIGURATION



SYMBOL



ABSOLUTE MAXIMUM RATINGS

Rating	Symbol	Value	Unit
Drain to Current — Continuous	I_D	27.5	Α
- Pulsed	I_{DM}	82.5	
Gate-to-Source Voltage — Continue	V_{GS}	±30	V
Total Power Dissipation – TO3P	P_D	270	W
– TO247		240	W/°C
Derate above 25℃ – TO3P		2.3	
– TO247		2.2	
Operating and Storage Temperature Range	T_J, T_{STG}	-55 to 150	$^{\circ}\!\mathbb{C}$
Single Pulse Drain-to-Source Avalanche Energy $-T_J = 25^{\circ}$ C ($V_{DD} = 100V$, $V_{GS} = 10V$, $I_L = 26A$, $L = 10mH$, $R_G = 25\Omega$)	E _{AS}	3380	mJ
Thermal Resistance — Junction to Case -TO3P	θ_{JC}	0.44	°C/W
Junction to Case -TO247		0.56	
 Junction to Ambient -TO3P, TO247 	θ_{JA}	40	
Maximum Lead Temperature for Soldering Purposes, 1/8" from case for 10 seconds	TL	260	$^{\circ}\mathbb{C}$
ESD SENSITIVITY — HBM, C=100pF, R=1.5kΩ	Vesd	2000	V





ORDERING INFORMATION

Part Number	Package
GPT28N50GN3P*	TO-3P
GPT28N50GN247*	TO-247

*Note: G : Suffix for PB Free Product

ELECTRICAL CHARACTERISTIC

Unless otherwise specified, $T_J = 25^{\circ}C$.

			GPT28N50			
Characteristic		Symbol	Min	Тур	Max	Units
Drain-Source Breakdown Voltage		500			V	
$(V_{GS} = 0 \text{ V}, I_D = 250 \ \mu \text{ A})$	$V_{(BR)DSS}$	500			V	
Drain-Source Leakage Current				1	uA	
$(V_{DS} = 500 \text{ V}, V_{GS} = 0 \text{ V})$	I _{DSS}				uA	
Gate-Source Leakage Current-Forwa	I _{GSSE}			100	nA	
$(V_{gsf} = 30 \text{ V}, V_{DS} = 0 \text{ V})$	IGSSF					
Gate-Source Leakage Current-Reverse		I _{GSSR}			100	nA
$(V_{gsr} = 30 \text{ V}, V_{DS} = 0 \text{ V})$	$V_{gsr} = 30 \text{ V}, V_{DS} = 0 \text{ V}$				100	IIA
Gate Threshold Voltage	Voltage		3		5	V
$(V_{DS} = V_{GS}, I_{D} = 250 \ \mu A)$	V _{GS(th)}	3		3	V	
Static Drain-Source On-Resistance (R _{DS(on)}		0.12	0.16	Ω	
Forward Transconductance (V _{DS} = 5	g _{FS}		31		S	
Input Capacitance	$(V_{DS} = 25 \text{ V}, V_{GS} = 0 \text{ V},$	C_{iss}		5943		pF
Output Capacitance	$(V_{DS} - 25 V, V_{GS} - 0 V,$ f = 1.0 MHz)	C_{oss}		580		pF
Reverse Transfer Capacitance	1 = 1.0 Wil 12)	C_{rss}		25.1		pF
Turn-On Delay Time	(V _{DD} = 250 V, I _D = 28 A,	t _{d(on)}		56		ns
Rise Time		t _r		127		ns
Turn-Off Delay Time	$R_G = 25\Omega)$ *	$t_{d(off)}$		144.3		ns
Fall Time		t _f		92.3		ns
Total Gate Charge	(V _{DS} = 400 V, I _D = 28 A,	Q_g		115		nC
Gate-Source Charge		Q_{gs}		24.3		nC
Gate-Drain Charge	V _{GS} = 10 V)*	Q_{gd}		39.1		nC
	SOURCE-DRAIN DIODE CHA	RACTERISTICS				
Forward On-Voltage(1)	// 00 A	V _{SD}			1.5	V
Forward Turn-On Time	(I _S = 28 A,	t _{on}		**		ns
Reverse Recovery Time	$d_{IS}/d_t = 100A/\mu s)$	t _{rr}		520		ns

^{*} Pulse Test: Pulse Width \leq 300 μ s, Duty Cycle \leq 2%

^{**} Negligible, Dominated by circuit inductance





TYPICAL ELECTRICAL CHARACTERISTICS

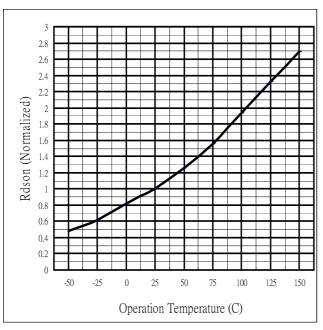


Fig 1. On-Resistance Variation with vs. Temperature

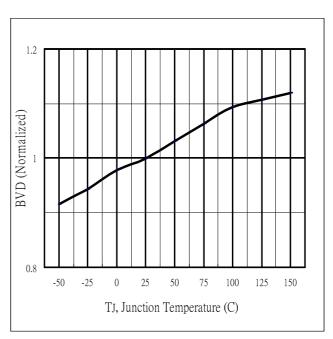


Fig.2 Breakdown Voltage Variation vs. Temperature

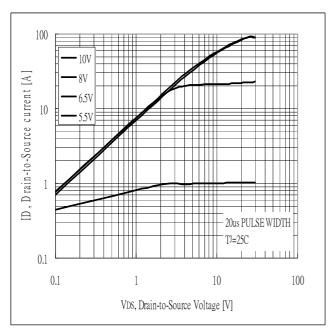


Fig 3. Typical Output Characteristics

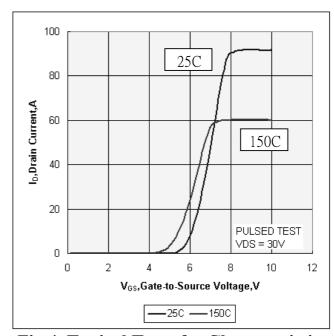


Fig 4. Typical Transfer Characteristics







Power Field Effect Transistor

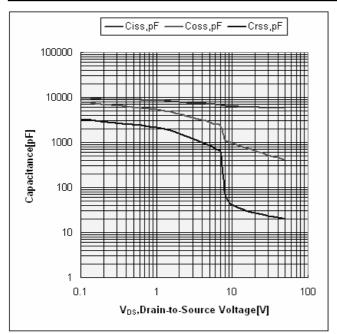


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

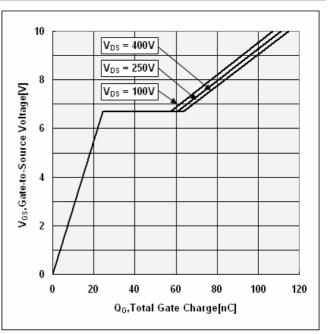
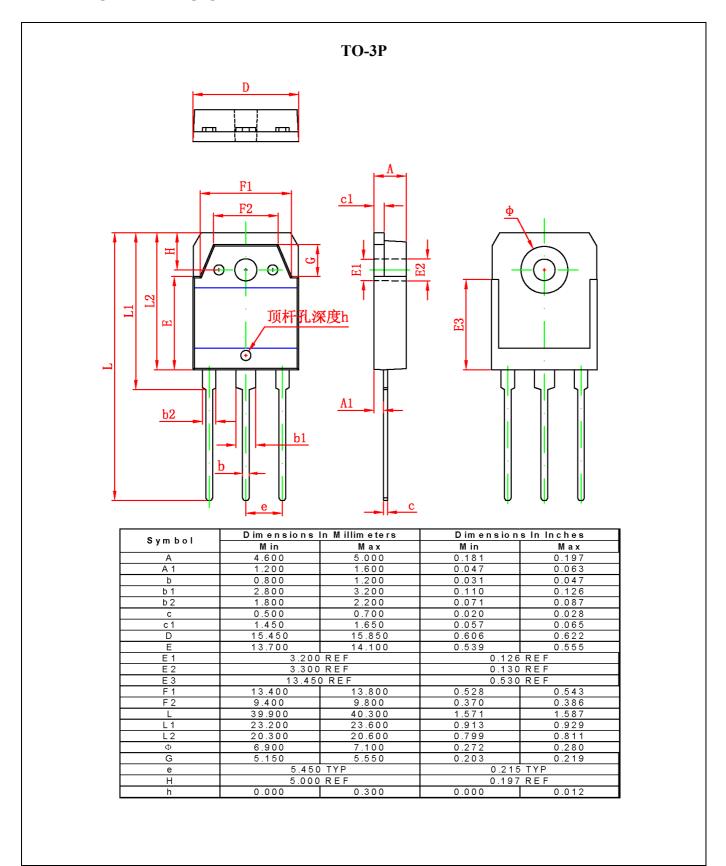


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage



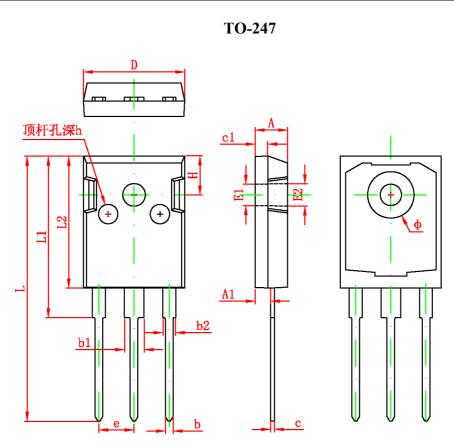


PACKAGE DIMENSION









Symphol	Dimensions In Millimeters		Dimensions In Inches		
Symbol	Min	Max	Min	Max	
Α	4.850	5.150	0.191	0.200	
A1	2.200	2.600	0.087	0.102	
b	1.000	1.400	0.039	0.055	
b1	2.800	3.200	0.110	0.126	
b2	1.800	2.200	0.071	0.087	
С	0.500	0.700	0.020	0.028	
c1	1.900	2.100	0.075	0.083	
D	15.450	15.750	0.608	0.620	
E1	3.500 REF		0.138 REF		
E2	3.600 REF		0.142 REF		
L	40.900	41.300	1.610	1.626	
L1	24.800	25.100	0.976	0.988	
L2	20.300	20.600	0.799	0.811	
Ф	7.100	7.300	0.280	0.287	
е	5.450 TYP		0.215	5 TYP	
Н	5.980	5.980 REF 0.235 REF		REF	
h	0.000	0.300	0.000	0.012	





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